查询TIBPAL16L8-25**TIBPAL16L8-25C**, TIBPAL16**R4-25C**寿**亚语PA栏16**R6-250动**河语PA**L16R8-25C TIBPAL16L8-30M, TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M LOW-POWER HIGH-PERFORMANCE *IMPACT* TM *PAL*[®] CIRCUITS SRP5059 - FEBRUARY 1984 - REVISED APRIL 2000

• High-Performance Operation: Propagation Delay C Suffix . . . 25 ns Max M Suffix . . . 30 ns Max

- Functionally Equivalent, but Faster Than PAL16L8A, PAL16R4A, PAL16R6A, and PAL16R8A
- Power-Up Clear on Registered Devices (All Register Outputs Are Set High, but Voltage Levels at the Output Pins Go Low)
- Package Options Include Both Plastic and Ceramic Chip Carriers in Addition to Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

DEVICE	I INPUTS	3-STATE O OUTPUTS	REGISTERED Q OUTPUTS	I/O PORTS
PAL16L8	10	2	0	6
PAL16R4	8	0	4 (3-state buffers)	0 4
PAL16R6	8	0	6 (3-state buffers)	2
PAL16R8	8	0	8 (3-state buffers)	0

description

These programmable array logic devices feature high speed and functional equivalency when compared with currently available devices. These IMPACT™ circuits combine the latest Advanced Low-Power Schottky technology with proven titanium-tungsten fuses to provide reliable, high-performance substitutes for conventional TTL logic. Their easy programmability allows for quick design of custom functions and typically results in a more compact circuit board. In addition, chip carriers are available for further reduction in board space.

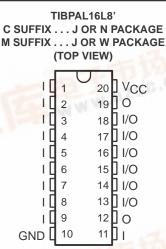
The TIBPAL16' C series is characterized from 0°C to 75°C. The TIBPAL16' M series is characterized for operation over the full military temperature range of –55°C to 125°C.

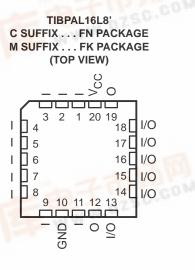


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

These devices are covered by U.S. Patent 4,410,987. IMPACT is a trademark of Texas Instruments. PAPISF registered trademark of Advanced Micro Devices Inc.



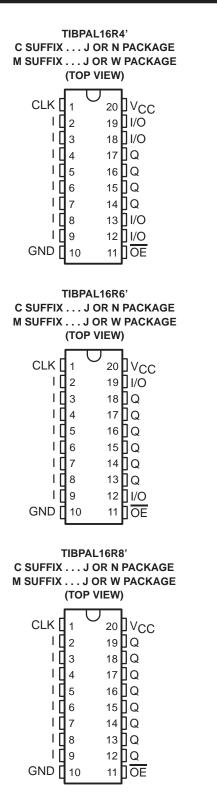


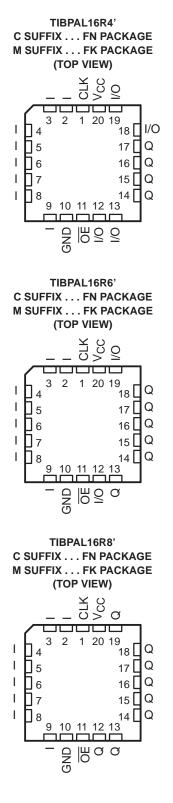




TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M LOW-POWER HIGH-PERFORMANCE IMPACT M PAL® CIRCUITS

SRPS059 FEBRUARY 1984 - REVISED APRIL 2000

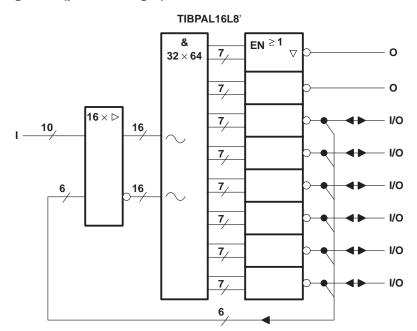




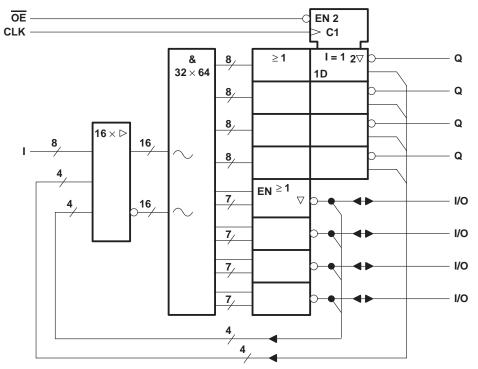


TIBPAL16L8-25C, TIBPAL16R4-25C TIBPAL16L8-30M, TIBPAL16R4-30M LOW-POWER HIGH-PERFORMANCE IMPACT TM PAL® CIRCUITS SRPS059 – FEBRUARY 1984 – REVISED APRIL 2000

functional block diagrams (positive logic)





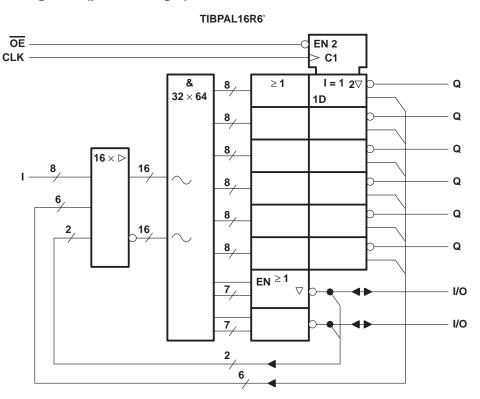


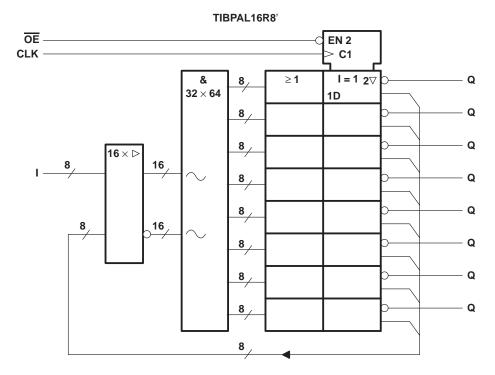
 \bigcirc denotes fused inputs



TIBPAL16R6-25C, TIBPAL16R8-25C TIBPAL16R6-30M, TIBPAL16R8-30M LOW-POWER HIGH-PERFORMANCE IMPACTTM PAL[®] CIRCUITS SRPS059 - FEBRUARY 1984 - REVISED APRIL 2000

functional block diagrams (positive logic)

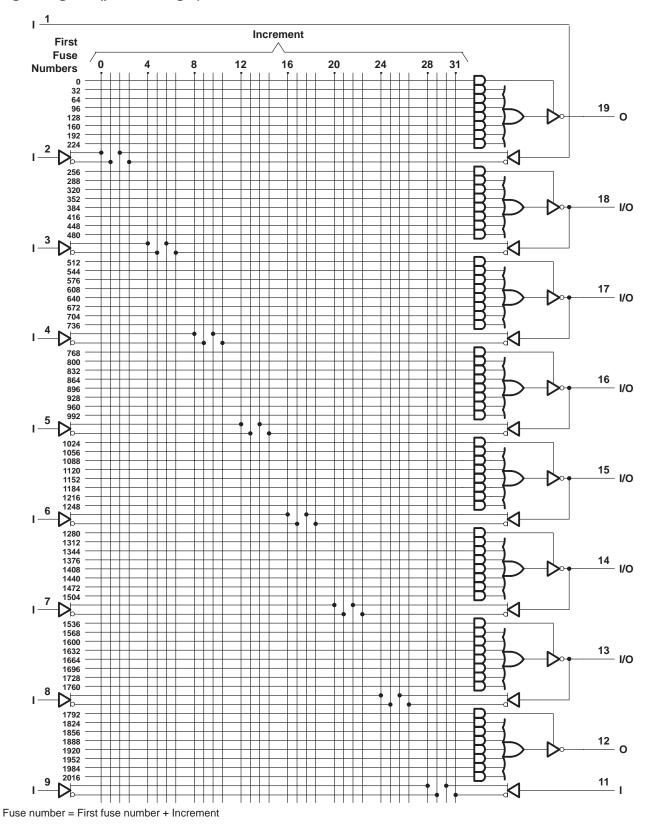




 \bigcirc denotes fused inputs

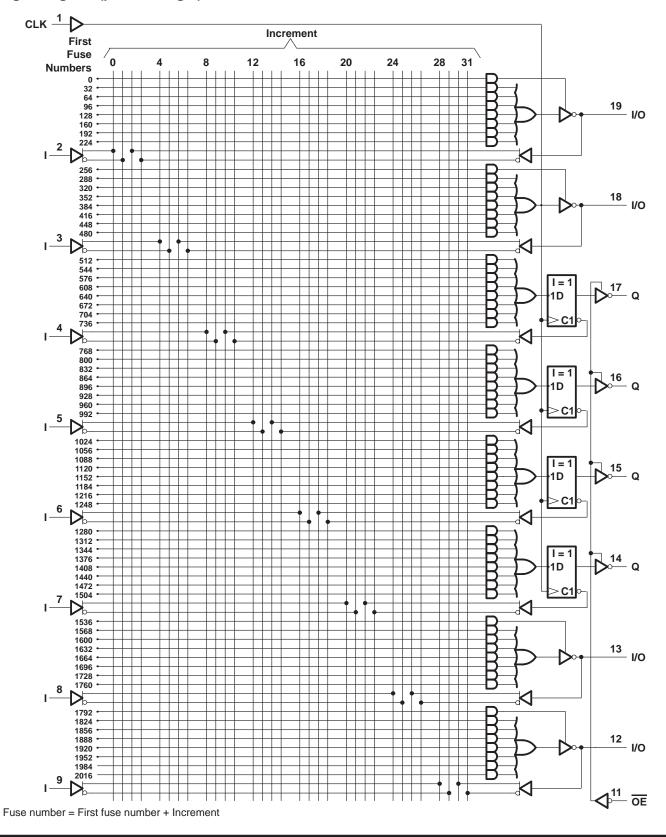


TIBPAL16L8-25C TIBPAL16L8-30M LOW-POWER HIGH-PERFORMANCE IMPACT TM PAL® CIRCUITS SRPS059 – FEBRUARY 1984 – REVISED APRIL 2000



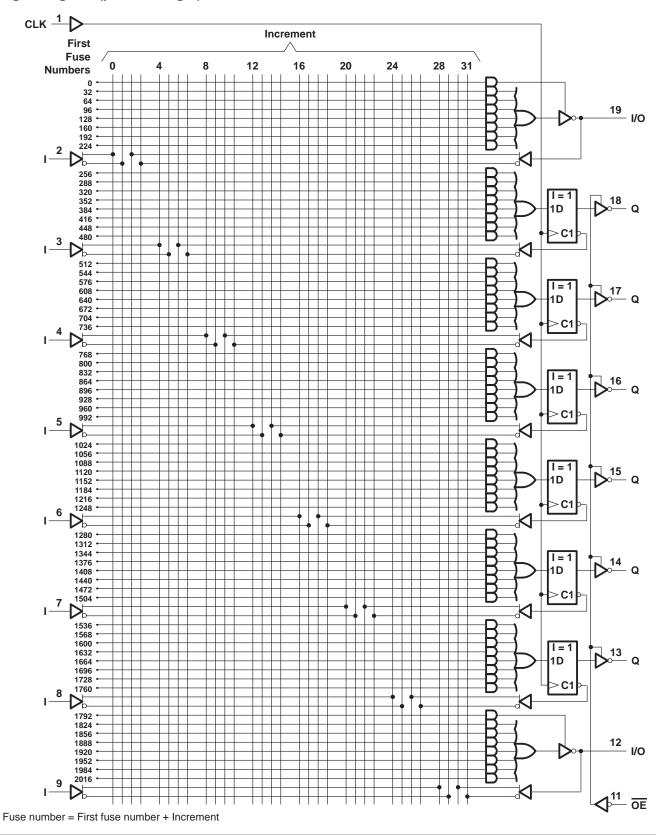


TIBPAL16R4-25C TIBPAL16R4-30M LOW-POWER HIGH-PERFORMANCE IMPACTTM PAL[®] CIRCUITS SRPS059 – FEBRUARY 1984 – REVISED APRIL 2000



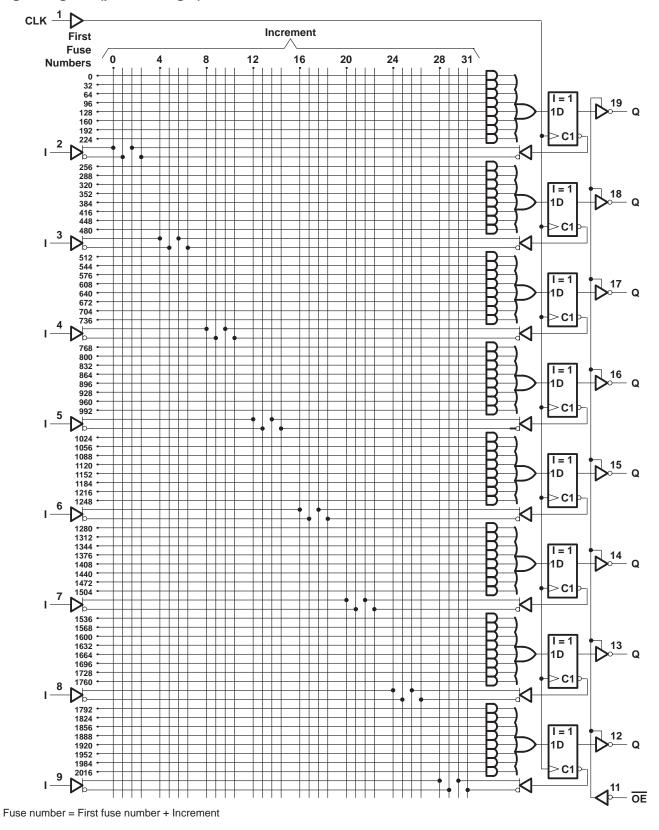


TIBPAL16R6-25C TIBPAL16R6-30M LOW-POWER HIGH-PERFORMANCE IMPACT TM PAL[®] CIRCUITS SRPS059 - FEBRUARY 1984 - REVISED APRIL 2000





TIBPAL16R8-25C TIBPAL16R8-30M LOW-POWER HIGH-PERFORMANCE IMPACTTM PAL[®] CIRCUITS SRPS059 – FEBRUARY 1984 – REVISED APRIL 2000





TIBPAL16L8-25C, TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C LOW-POWER HIGH-PERFORMANCE *IMPACT*™ *PAL*[®] CIRCUITS

SRPS059 - FEBRUARY 1984 - REVISED APRIL 2000

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	0°C to 75°C
Storage temperature range, T _{stg}	−65°C to 150°C

NOTE 1: These ratings apply, except for programming pins, during a programming cycle.

recommended operating conditions

			MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.75	5	5.25	V
VIH	High-level input voltage		2		5.5	V
VIL	Low-level input voltage				0.8	V
ЮН	DH High-level output current				-3.2	mA
IOL	Low-level output current				24	mA
fclock	Clock frequency				30	MHz
	Pulse duration, clock (see Note 2)	High	10			ns
t _w	Pulse duration, clock (see Note 2)		15			115
t _{su}	Setup time, input or feedback before clock↑					ns
t _h	Hold time, input or feedback after clock↑					ns
ТА	Operating free-air temperature				75	°C

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency, f_{clock}. The minimum pulse durations specified are for clock high or low only, but not for both simultaneously.



TIBPAL16L8-25C, TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C LOW-POWER HIGH-PERFORMANCE *IMPACT*[™] *PAL*[®] CIRCUITS

SRPS059 - FEBRUARY 1984 - REVISED APRIL 2000

electrical characteristics over recommended operating free-air temperature range

I	PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
VIK		V _{CC} = 4.75 V,	lı = -18 mA				-1.5	V
VOH		V _{CC} = 4.75 V,	I _{OH} = -3.2 mA		2.4	3.3		V
VOL		V _{CC} = 4.75 V,	I _{OL} = 24 mA			0.35	0.5	V
10711	Outputs		V _O = 2.7 V				20	
IOZH	I/O ports	$V_{CC} = 5.25 V,$					100	μA
1	Outputs		$\lambda = 0.4 \lambda$				-20	μA
IOZL	I/O ports	$V_{CC} = 5.25 V,$	V _O = 0.4 V				-250	μΑ
Ц		V _{CC} = 5.25 V,	V _I = 5.5 V				0.1	mA
lιΗ		V _{CC} = 5.25 V,	V _I = 2.7 V				20	μΑ
IIL		V _{CC} = 5.25 V,	V _I = 0.4 V				-0.25	mA
10‡		V _{CC} = 5.25 V,	V _O = 2.25 V		-30		-125	mA
ICC		V _{CC} = 5.25 V,	$V_{I} = 0,$	Outputs open		75	100	mA

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] The output conditions have been chosen to produce a current that closely approximates one-half of the short-circuit output current, I_{OS}.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	түр†	МАХ	UNIT
fmax				30			MHz
^t pd	I, I/O	O, I/O]		15	25	ns
^t pd	CLK↑	Q	R1 = 500 Ω,		10	15	ns
ten	OE↓	Q	R2 = 500 Ω,		15	20	ns
^t dis	OE↑	Q	See Figure 3		10	20	ns
ten	I, I/O	O, I/O]		14	25	ns
^t dis	I, I/O	O, I/O			13	25	ns

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



TIBPAL16L8-30M, TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M LOW-POWER HIGH-PERFORMANCE *IMPACT* ™ *PAL*[®] CIRCUITS

SRPS059 - FEBRUARY 1984 - REVISED APRIL 2000

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	
Input voltage (see Note 1)	5.5 V
Voltage applied to disabled output (see Note 1)	5.5 V
Operating free-air temperature range	. −55°C to 125°C
Storage temperature range, T _{stg}	. −65°C to 150°C

NOTE 1: These ratings apply, except for programming pins, during a programming cycle.

recommended operating conditions

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	V
VIH	High-level input voltage		2		5.5	V
VIL	Low-level input voltage				0.8	V
ЮН	High-level output current				-2	mA
IOL	Low-level output current				12	mA
fclock	Clock frequency				25	MHz
	Pulse duration, clock (see Note 2)	High				ns
tw	Pulse duration, clock (see Note 2)		20			115
t _{su}	Setup time, input or feedback before clock↑					ns
th	Hold time, input or feedback after clock↑					ns
ТА	Operating free-air temperature				125	°C

NOTE 2: The total clock period of clock high and clock low must not exceed clock frequency, f_{clock}. The minimum pulse durations specified are for clock high or low only, but not for both simultaneously.



TIBPAL16L8-30M, TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M LOW-POWER HIGH-PERFORMANCE *IMPACT™ PAL*[®] CIRCUITS

SRPS059 - FEBRUARY 1984 - REVISED APRIL 2000

electrical characteristics over recommended operating free-air temperature range

P	PARAMETER		TEST CONDITION	S	MIN	TYP [†]	MAX	UNIT	
VIK		$V_{CC} = 4.5 V,$	lj = -18 mA				-1.5	V	
Vон		V _{CC} = 4.5 V,	I _{OH} = -2 mA		2.4	3.2		V	
VOL		V _{CC} = 4.5 V,	I _{OL} = 12 mA			0.25	0.4	V	
1	Outputs						20	۵	
IOZH	I/O ports	V _{CC} = 5.5 V	V _O = 2.7 V				100	μA	
1	Outputs						-20		
IOZL	I/O ports	$V_{\rm CC} = 5.5 V,$	V _O = 0.4 V		-250			μA	
1.	Pin 1, 11						0.2	A	
łı	All others	$V_{CC} = 5.5 V,$	V _I = 5.5 V				0.1	mA	
	Pin 1, 11						50		
ЧΗ	I/O ports	V _{CC} = 5.5 V,	V _I = 2.7 V				100	μA	
	All others						20		
L.	I/O ports						-0.25	mA	
All others		$v_{CC} = 5.5 v,$	$V_{CC} = 5.5 \text{ V}, \qquad V_{I} = 0.4 \text{ V}$				-0.2		
los‡		V _{CC} = 5.5 V,	V _O = 0.5 V		-30		-250	mA	
ICC		V _{CC} = 5.5 V,	$V_{I} = 0,$	Outputs open		75	105	mA	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

* Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. Set V_O at 0.5 V to avoid test-equipment degradation.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	түр†	МАХ	UNIT
fmax				25			MHz
^t pd	I, I/O	O, I/O			15	30	ns
^t pd	CLK↑	Q	R1 = 390 Ω,		10	20	ns
t _{en}	OE↓	Q	R2 = 750 Ω,		15	25	ns
^t dis	OE↑	Q	See Figure 4		10	25	ns
t _{en}	I, I/O	O, I/O]		14	30	ns
^t dis	I, I/O	O, I/O			13	30	ns

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.

programming information

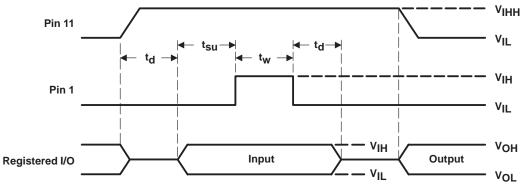
Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic also is available, upon request, from the nearest TI field sales office or local authorized TI distributor, by calling Texas Instruments at +1 (972) 644–5580, or by visiting the TI Semiconductor Home Page at www.ti.com/sc.

preload procedure for registered outputs (see Figure 1 and Note 3)

The output registers can be preloaded to any desired state during device testing. This permits any state to be tested without having to step through the entire state-machine sequence. Each register is preloaded individually by following the steps given below.

- Step 1. With V_{CC} at 5 V and Pin 1 at V_{IL} , raise Pin 11 to V_{IHH} .
- Step 2. Apply either VIL or VIH to the output corresponding to the register to be preloaded.
- Step 3. Pulse Pin 1, clocking in preload data.
- Step 4. Remove output voltage, then lower Pin 11 to V_{IL}. Preload can be verified by observing the voltage level at the output pin.



NOTE 3: $t_d = t_{SU} = t_h = 100 \text{ ns to } 1000 \text{ ns } V_{IHH} = 10.25 \text{ V to } 10.75 \text{ V}$

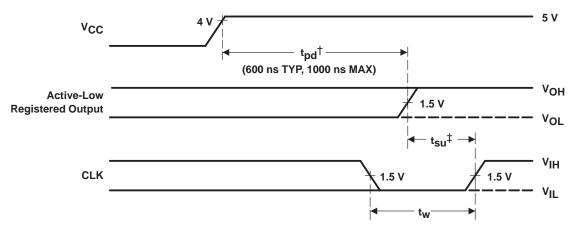
Figure 1. Preload Waveforms



TIBPAL16L8-25C, TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C TIBPAL16L8-30M, TIBPAL16R4-30M, TIBPAL16R6-30M, TIBPAL16R8-30M LOW-POWER HIGH-PERFORMANCE IMPACT M PAL® CIRCUITS SRPS059 – FEBRUARY 1984 – REVISED APRIL 2000

power-up reset (see Figure 2)

Following power up, all registers are set high. This feature provides extra flexibility to the system designer and is especially valuable in simplifying state-machine initialization. To ensure a valid power-up reset, it is important that the rise of V_{CC} be monotonic. Following power-up reset, a low-to-high clock transition must not occur until all applicable input and feedback setup times are met.



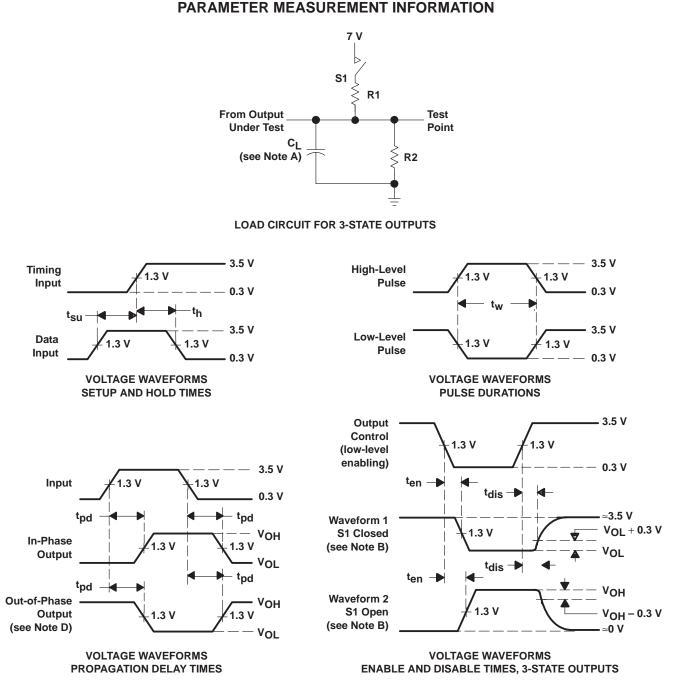
[†] This is the power-up reset time and applies to registered outputs only. The values shown are from characterization data. [‡]This is the setup time for input or feedback.

Figure 2. Power-Up Reset Waveforms



TIBPAL16L8-25C, TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C LOW-POWER HIGH-PERFORMANCE *IMPACT* ™ *PAL*[®] CIRCUITS

SRPS059 - FEBRUARY 1984 - REVISED APRIL 2000



NOTES: A. CL includes probe and jig capacitance and is 50 pF for t_{pd} and t_{en} , 5 pF for t_{dis} .

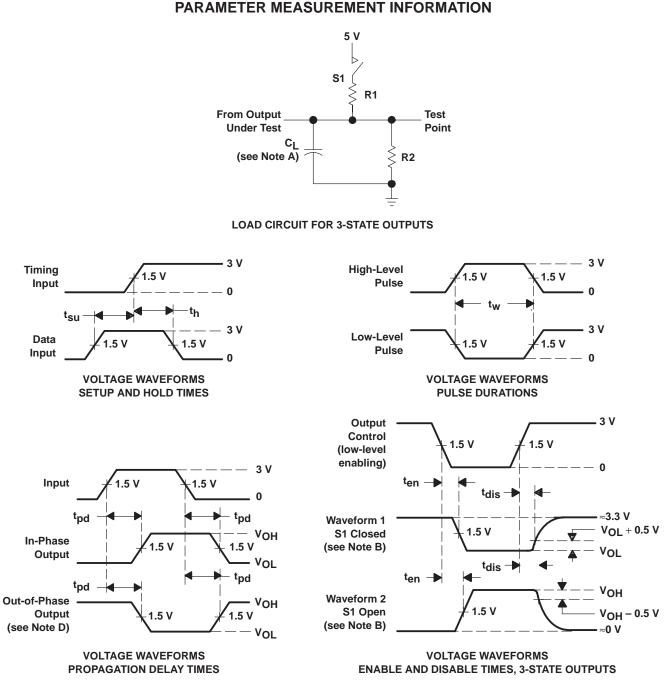
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
 Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r = t_f \leq 2 ns, duty cycle = 50%
- D. When measuring propagation delay times of 3-state outputs from low to high, switch S1 is closed. When measuring propagation delay times of 3-state outputs from high to low, switch S1 is open.
- E. Equivalent loads may be used for testing.

Figure 3. Load Circuit and Voltage Waveforms



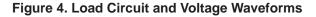
TIBPAL16L8-25C, TIBPAL16R4-25C, TIBPAL16R6-25C, TIBPAL16R8-25C LOW-POWER HIGH-PERFORMANCE *IMPACT*[™] *PAL*[®] CIRCUITS

SRPS059 - FEBRUARY 1984 - REVISED APRIL 2000



NOTES: A. CL includes probe and jig capacitance and is 50 pF for t_{pd} and t_{en} , 5 pF for t_{dis} .

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses have the following characteristics: PRR \leq 10 MHz, t_r = t_f \leq 2 ns, duty cycle = 50%
- D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.
- E. Equivalent loads may be used for testing.







PACKAGE OPTION ADDENDUM

4-Mar-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-85155052A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-8515505RA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
5962-8515505SA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
5962-85155062A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-8515506RA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
5962-8515506SA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
5962-85155072A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-8515507RA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
5962-8515507SA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
5962-85155082A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-8515508RA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
5962-8515508SA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
JM38510/50605BRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
JM38510/50606BRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
JM38510/50607BRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
JM38510/50608BRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16L8-25CFN	ACTIVE	PLCC	FN	20	46	None	Call TI	Level-1-220-UNLIM
TIBPAL16L8-25CN	ACTIVE	PDIP	Ν	20	20	None	Call TI	Level-NC-NC-NC
TIBPAL16L8-30MFKB	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16L8-30MJ	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16L8-30MJB	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16L8-30MWB	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R4-25CFN	ACTIVE	PLCC	FN	20	46	None	Call TI	Level-1-220-UNLIM
TIBPAL16R4-25CN	ACTIVE	PDIP	Ν	20	20	None	Call TI	Level-NC-NC-NC
TIBPAL16R4-30MFKB	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R4-30MJ	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R4-30MJB	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R4-30MWB	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R6-25CFN	ACTIVE	PLCC	FN	20	46	None	Call TI	Level-1-220-UNLIM
TIBPAL16R6-25CN	ACTIVE	PDIP	Ν	20	20	None	Call TI	Level-NC-NC-NC
TIBPAL16R6-30MFKB	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R6-30MJ	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R6-30MJB	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R6-30MWB	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R8-25CFN	ACTIVE	PLCC	FN	20	46	None	Call TI	Level-1-220-UNLIM
TIBPAL16R8-25CN	ACTIVE	PDIP	Ν	20	20	None	Call TI	Level-NC-NC-NC
TIBPAL16R8-30MFKB	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R8-30MJ	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R8-30MJB	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
TIBPAL16R8-30MWB	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

PACKAGE OPTION ADDENDUM



4-Mar-2005

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated